

## **DATASHEET**

# **Chip Phototransistor with Right Angle Lens EAPSV3010A0**



#### **Features**

- Fast response time
- High photo sensitivity
- Small junction capacitance
- Package in 8mm tape on 7" diameter reels.
- Pb free
- The product itself will remain within RoHS compliant version.
- Compliance with EU REACH

## **Descriptions**

- EAPSV3010A0 is a phototransistor in miniature SMD package which is molded in a water clear with right angle lens.
- The device is Spectrally matched to infrared emitting diode.

## **Applications**

- Miniature switch
- Counters and sorter
- Position sensor
- Infrared applied system

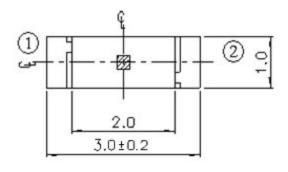
## **Device Selection Guide**

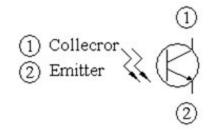
Part Category	Chip Material	Resin Color
PT	Silicon	Water Clear

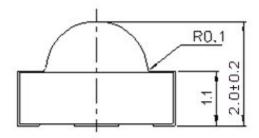
1



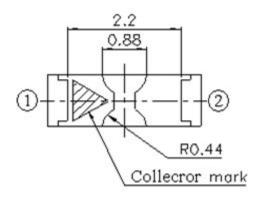
# **Package Dimensions**

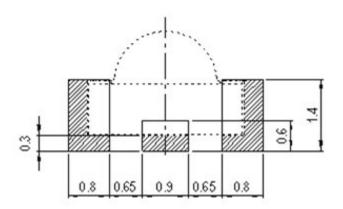






For reflow soldering (propose)





Notes: 1.All dimensions are in millimeters

- 2.Tolerances unless dimensions ±0.1mm
- 3. Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

**Expired Period: Forever** 



Absolute Maximum Ratings (Ta=25)

Parameter	Symbol	Rating	Units	
Collector Emitter Voltage	$V_{CEO}$	30	V	
Emitter Collector Voltage	$V_{ECO}$	5	V	
Collector Current	Ic	50	mA	
Operating Temperature	$T_{opr}$	-25 ~ +85		
Storage Temperature	$T_{stg}$	-40 ~ +85		
Soldering Temperature*1	$T_{sol}$	260		
Power Dissipation at (or below) 25 Free Air Temperature	$P_d$	75	mW	

Notes: \*1: Soldering time 5 seconds.

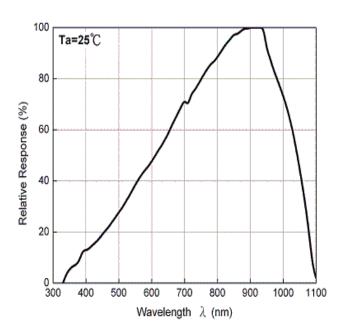
Electro-Optical Characteristics (Ta=25)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Units
Rang of Spectral Bandwidth	λ <sub>0.5</sub>		610	1	1040	nm
Wavelength of Peak Sensitivity	$\lambda_{P}$			940		nm
Collector Emitter Breakdown Voltage	BV <sub>CEO</sub>	I <sub>C</sub> =100µA Ee=0mW/cm <sup>2</sup>	30			V
Emitter Collector Breakdown Voltage	BV <sub>ECO</sub>	I <sub>E</sub> =100µA Ee=0mW/cm <sup>2</sup>	5			V
Collector Emitter Saturation Voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> =2mA Ee=1mW/cm <sup>2</sup>			0.4	V
Collector Dark Current	I <sub>CEO</sub>	V <sub>CE</sub> =20V Ee=0mW/cm <sup>2</sup>			100	nA
On State Collector Current	I <sub>C(ON)</sub>	V <sub>CE</sub> =5V Ee=1mW/cm <sup>2</sup>	0.3	1.14		mA



# **Typical Electro-Optical Characteristics Curves**

Fig.1 Spectral Sensitivity



Irradiance

100
VCE=5V
Ta=25 °C

10

0.01

1

3

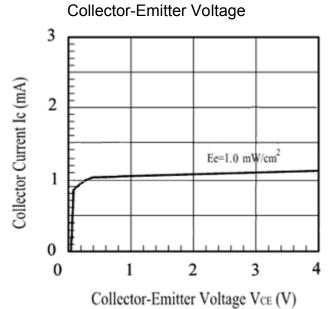
Irradiance Ee (mW/cm<sup>2</sup>)

5

0.5

Fig.2 Collector Current vs.

Fig.3 Collector Current vs.





#### **Precautions For Use**

#### 1. Over-current-proof

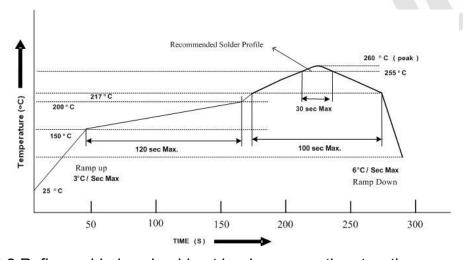
Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

### 2. Storage

- 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 10 ~30 and 90%RH or less.
- 2.3 The LEDs suggested be used within one year.
- 2.4 After opening the package, the devices must be stored at 10°C~30°C and ≤ 60%RH, and used within 168 hours (floor life). If unused LEDs remain, it should be stored in moisture proof packages.
- 2.5 If the moisture absorbent material (desiccant material) has faded or unopened bag has exceeded the shelf life or devices (out of bag) have exceeded the floor life, baking treatment is required.
- 2.6 If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure or recommend the following conditions:
  - 96 hours at 60°C ± 5°C and < 5 % RH (reeled/tubed/loose units)

#### 3. Soldering Condition

3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

Approved

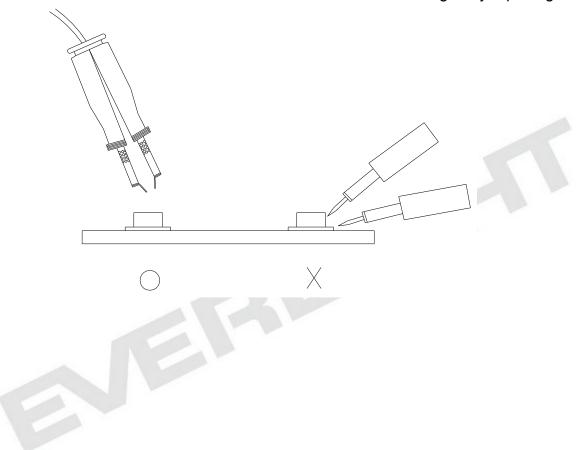


#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350 for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

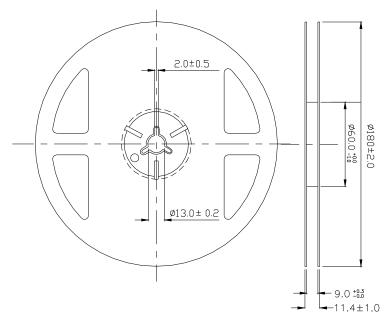
#### 5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



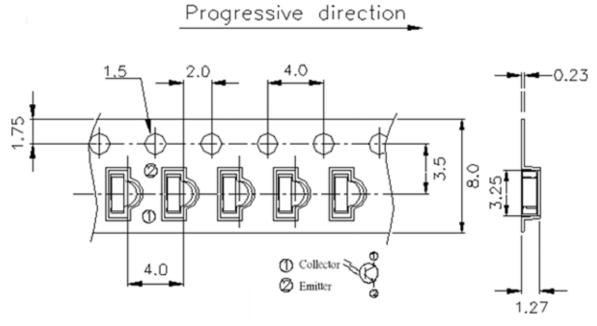


# **Package Dimensions**



Note: The tolerances unless mentioned are ±0.1mm, unit: mm

# Carrier Tape Dimensions: Loaded quantity 2000 PCS per reel



Note: The tolerances unless mentioned are ±0.1mm, unit: mm



## **Label Form Specification**



CPN: Customer's Production Number

P/N: Production Number QTY: Packing Quantity

CAT: Ranks

HUE: Peak Wavelength

REF: Reference

LOT No: Lot Number

#### **Notes**

- 1. Above specification may be changed without notice. Everlight Americas will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. Everlight Americas assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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